

99. (Previously Presented) The semiconductor structure of claim 98, wherein said photo-definable layer comprises plasma polymerized methylsilane (PPMS).

100. (Previously Presented) The semiconductor structure of claim 99, wherein said conductive layer forms an interconnect structure within a semiconductor memory device.

### REMARKS

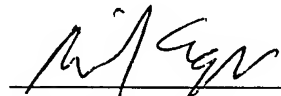
#### Status of Claims

Claims 1-54 have been canceled. Claims 55, 59, 62, 71, 84, and 97 have been amended. Claims 55-100 are pending in the case.

#### Conclusion

The examiner is invited to contact the undersigned at the phone number indicated below with any questions or comments, or to otherwise facilitate expeditious and compact prosecution of the application.

Respectfully submitted,



---

Richard D. Egan  
Registration No. 36,788  
Attorney for Applicant

O'KEEFE, EGAN & PETERMAN, LLP  
1101 Capital of Texas Highway South  
Building C, Suite 200  
Austin, Texas 78746  
(512) 347-1611  
FAX: (512) 347-1615